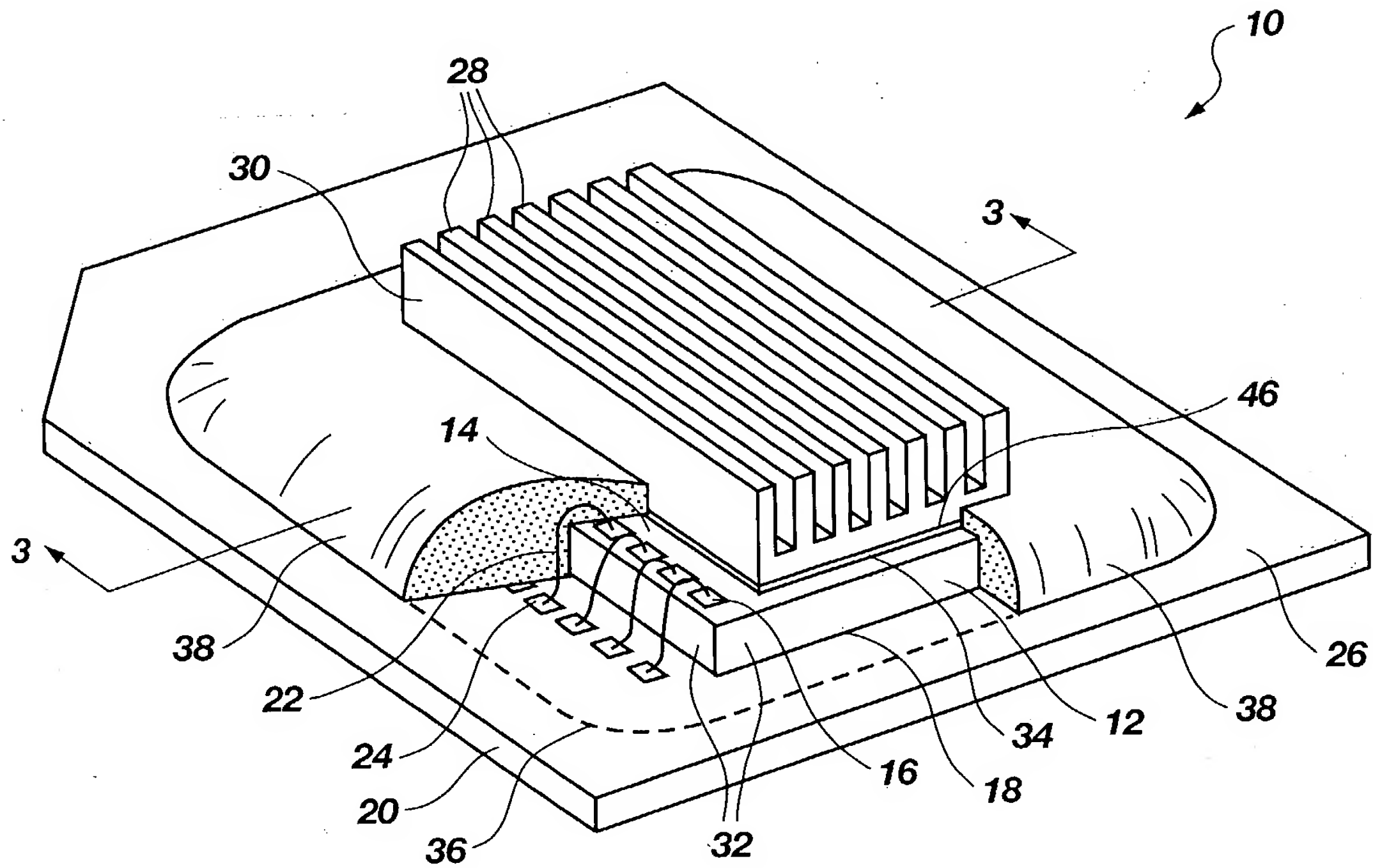
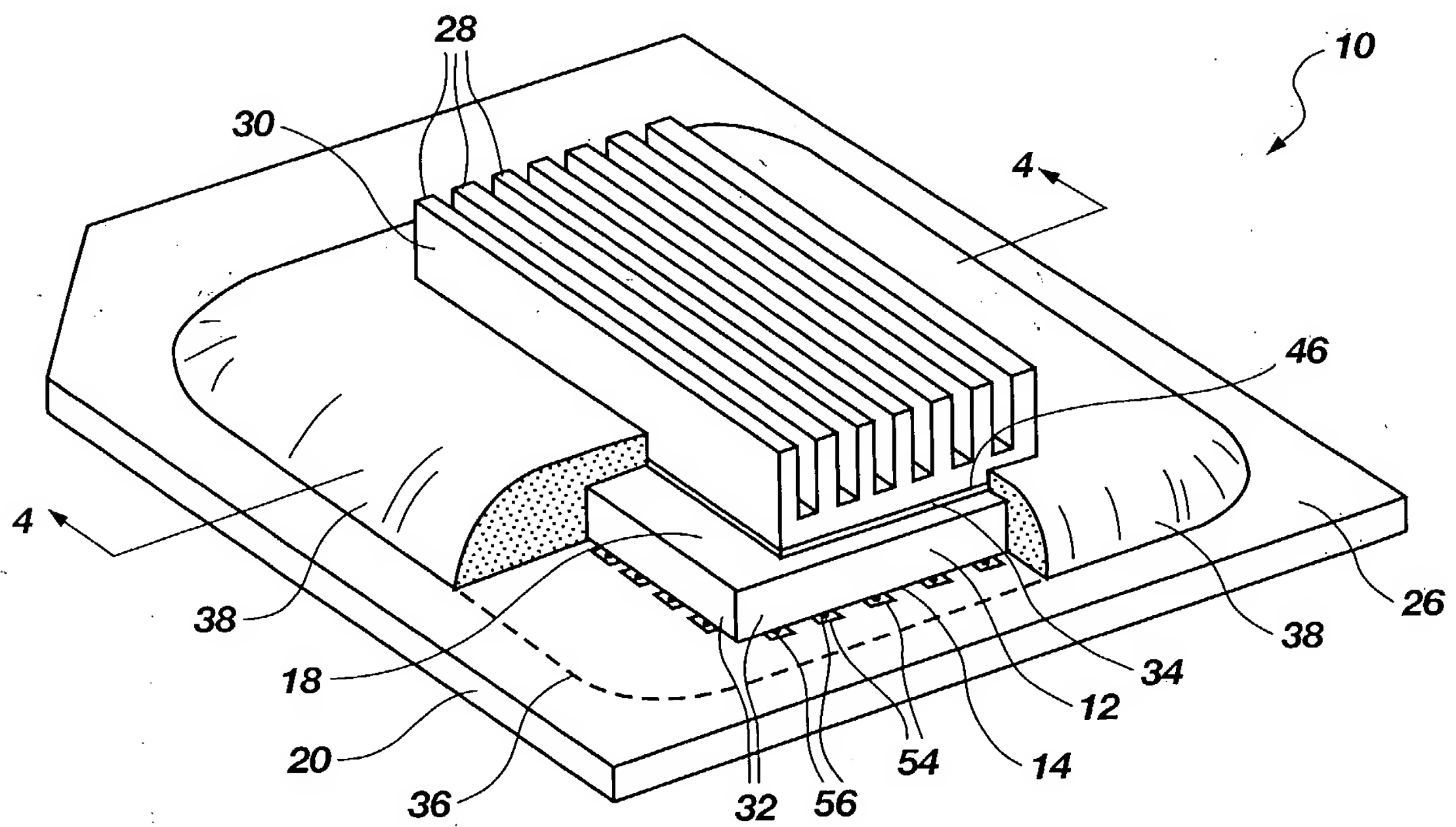


1/6

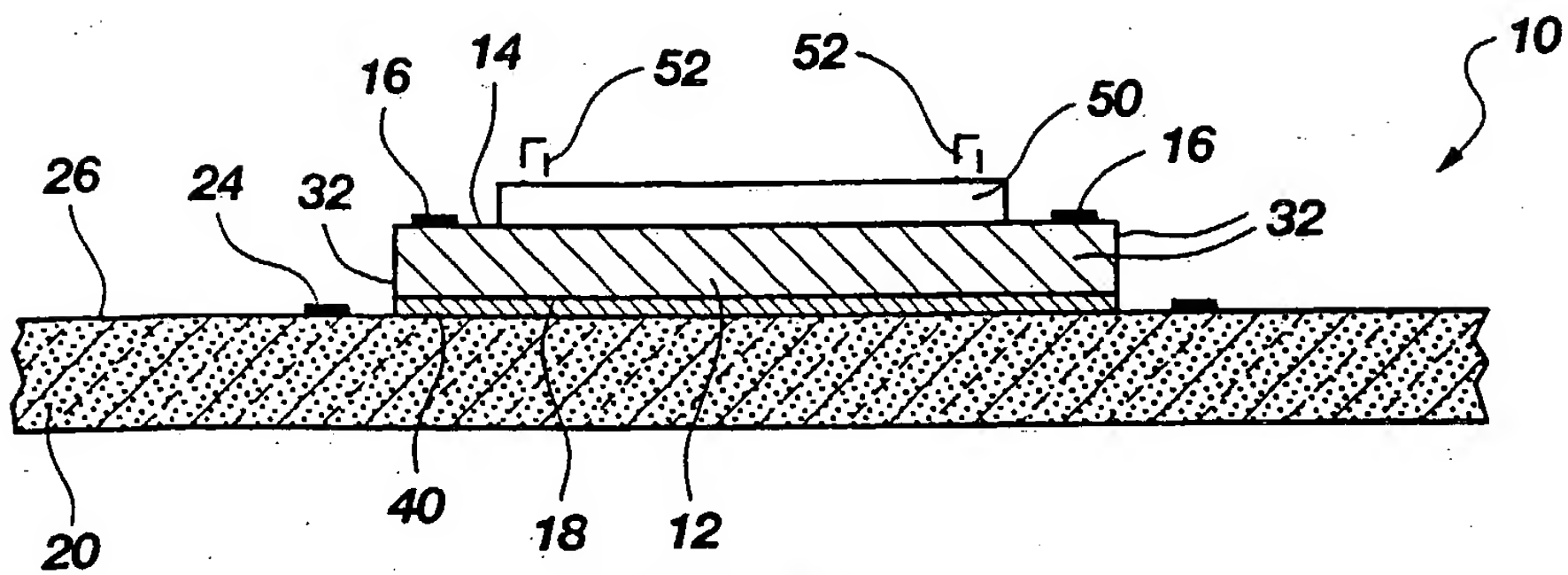


**Fig. 1**

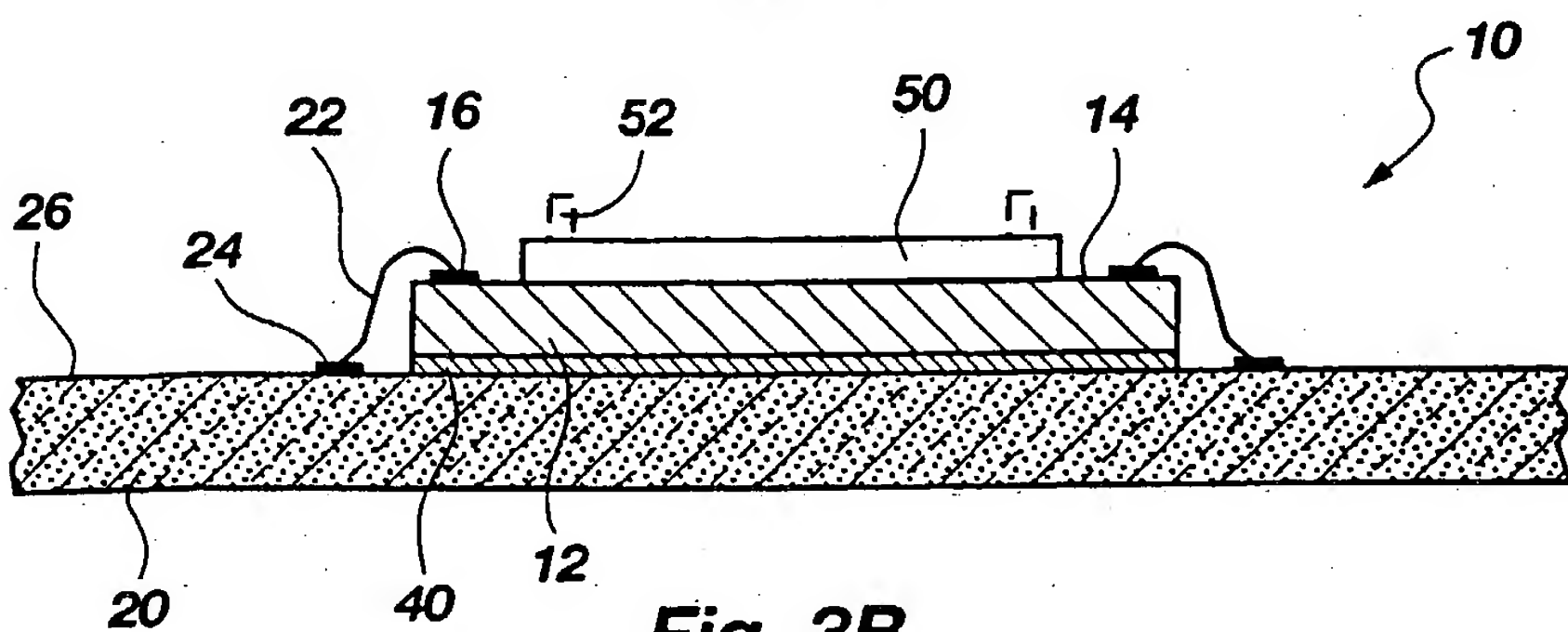


**Fig. 2**

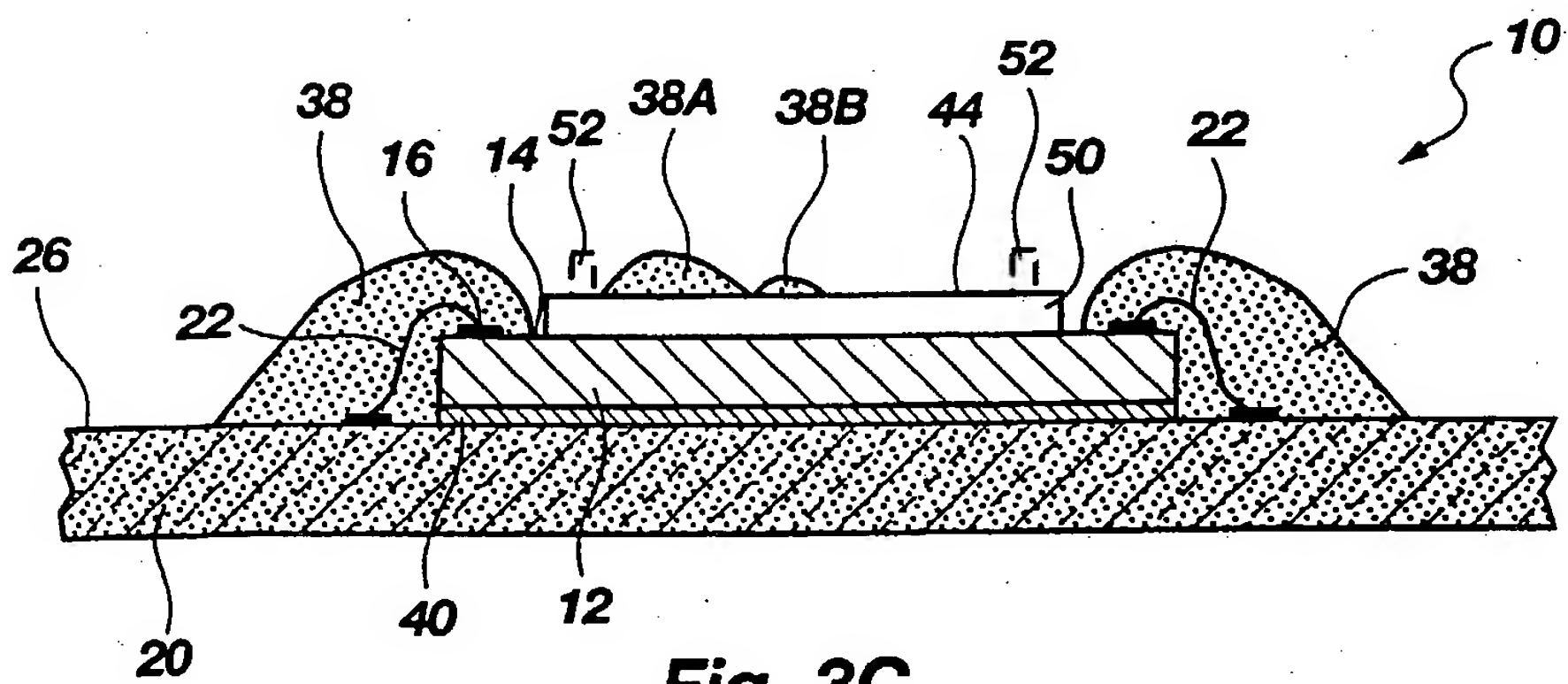
2/6



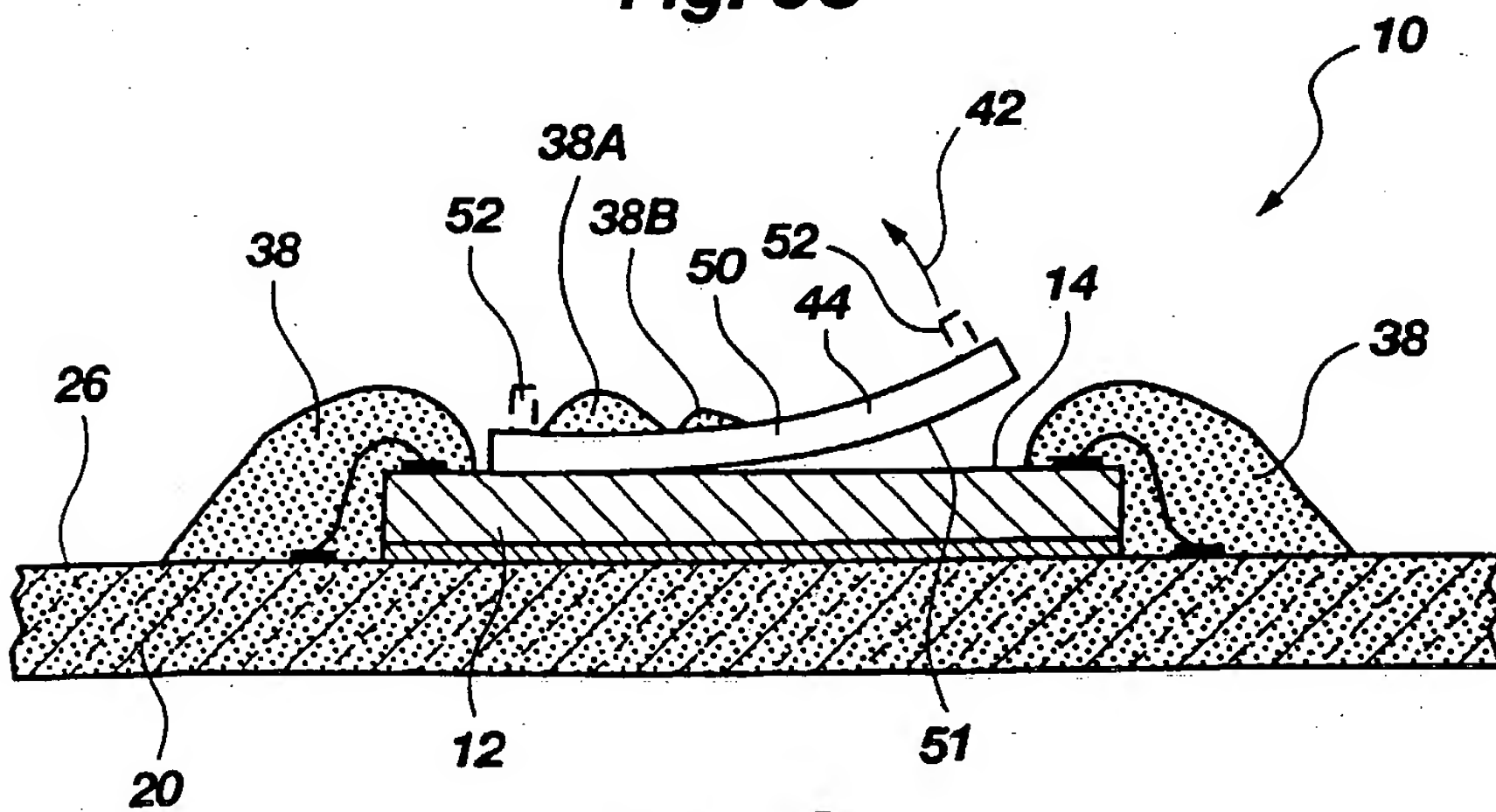
**Fig. 3A**



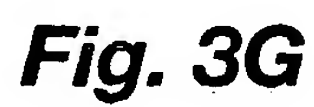
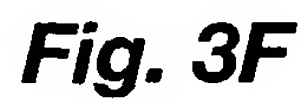
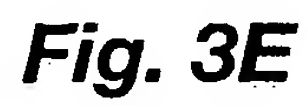
**Fig. 3B**



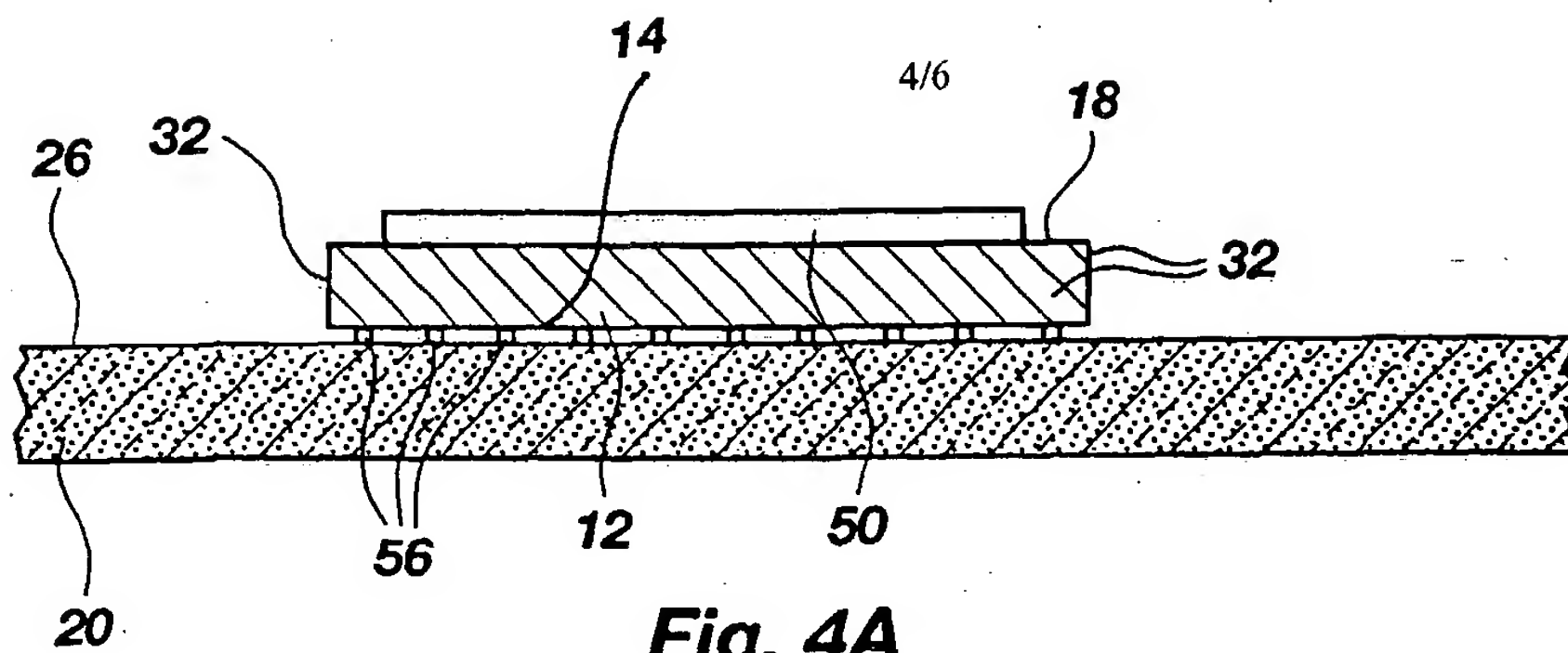
**Fig. 3C**



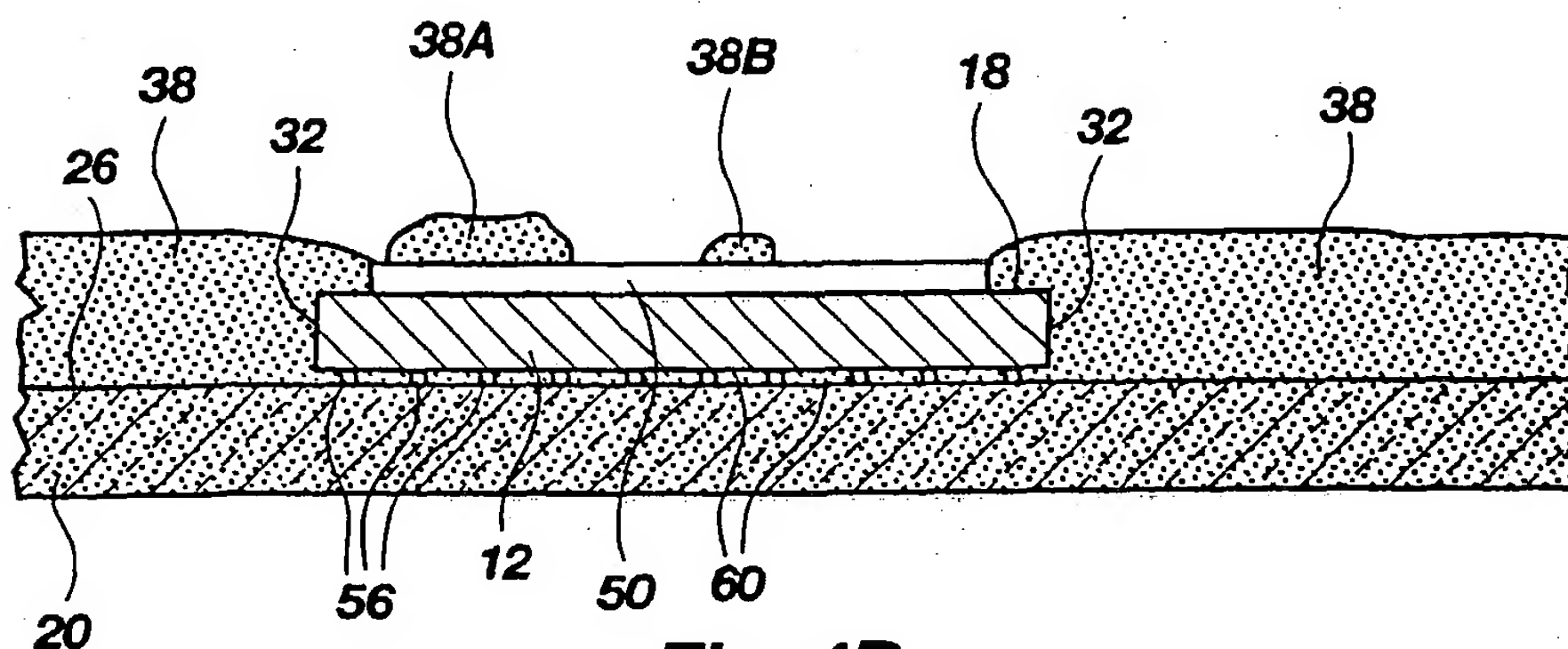
**Fig. 3D**



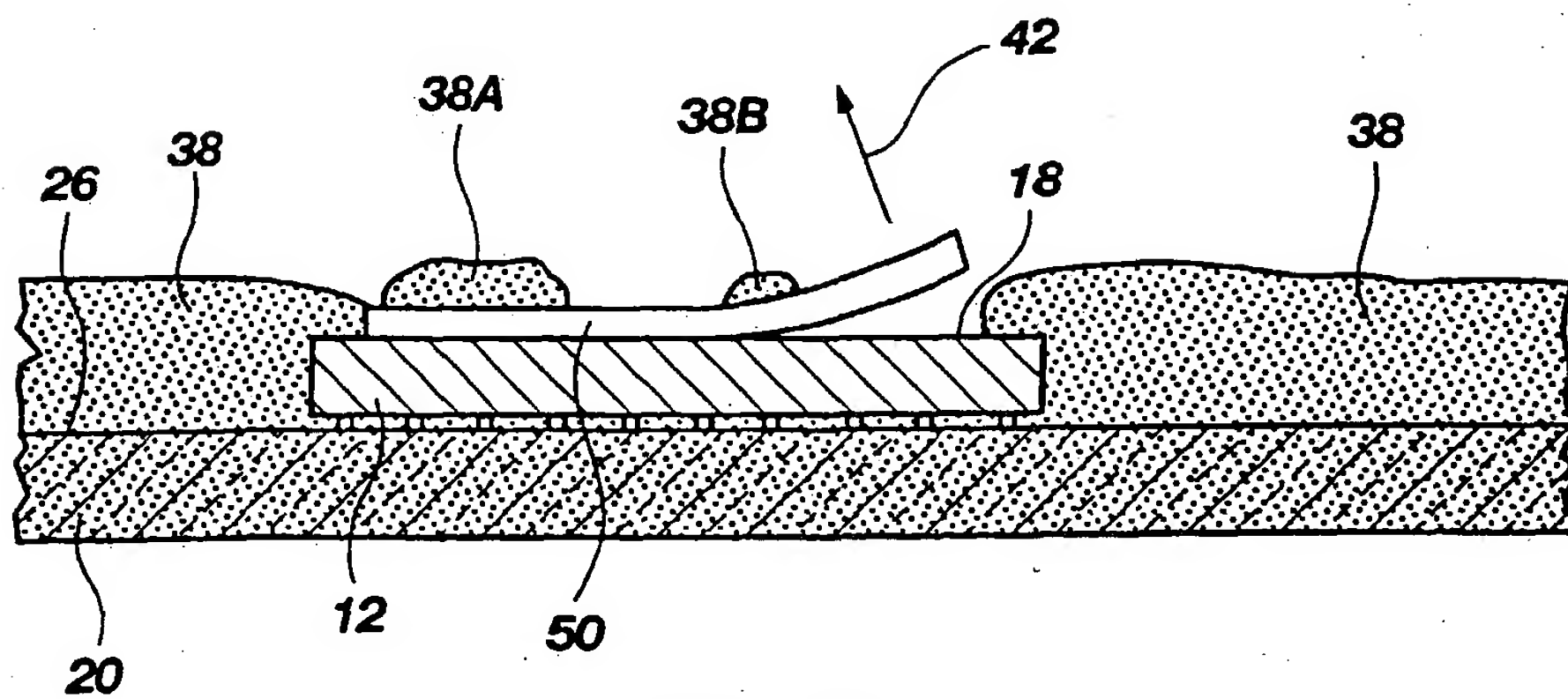
**Inventor:** David R. Hembree  
**Docket No.:** 3592.8US



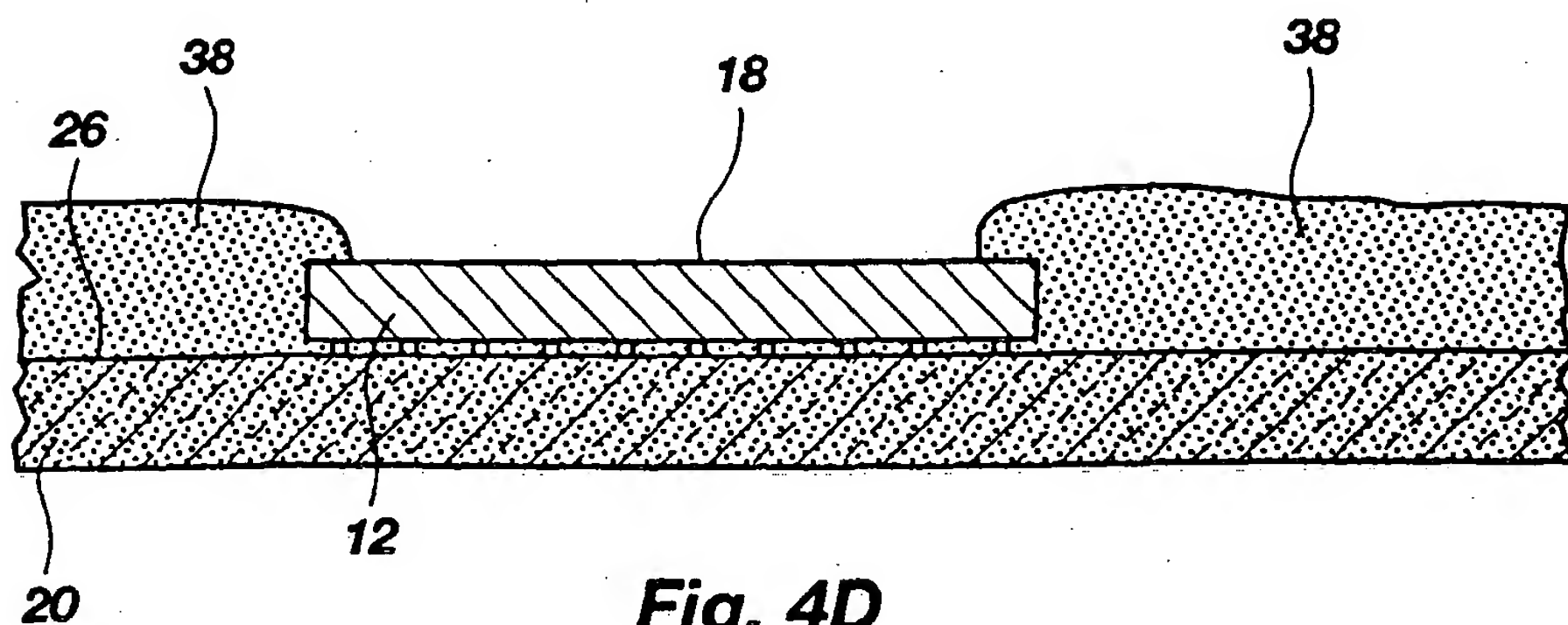
**Fig. 4A**



**Fig. 4B**



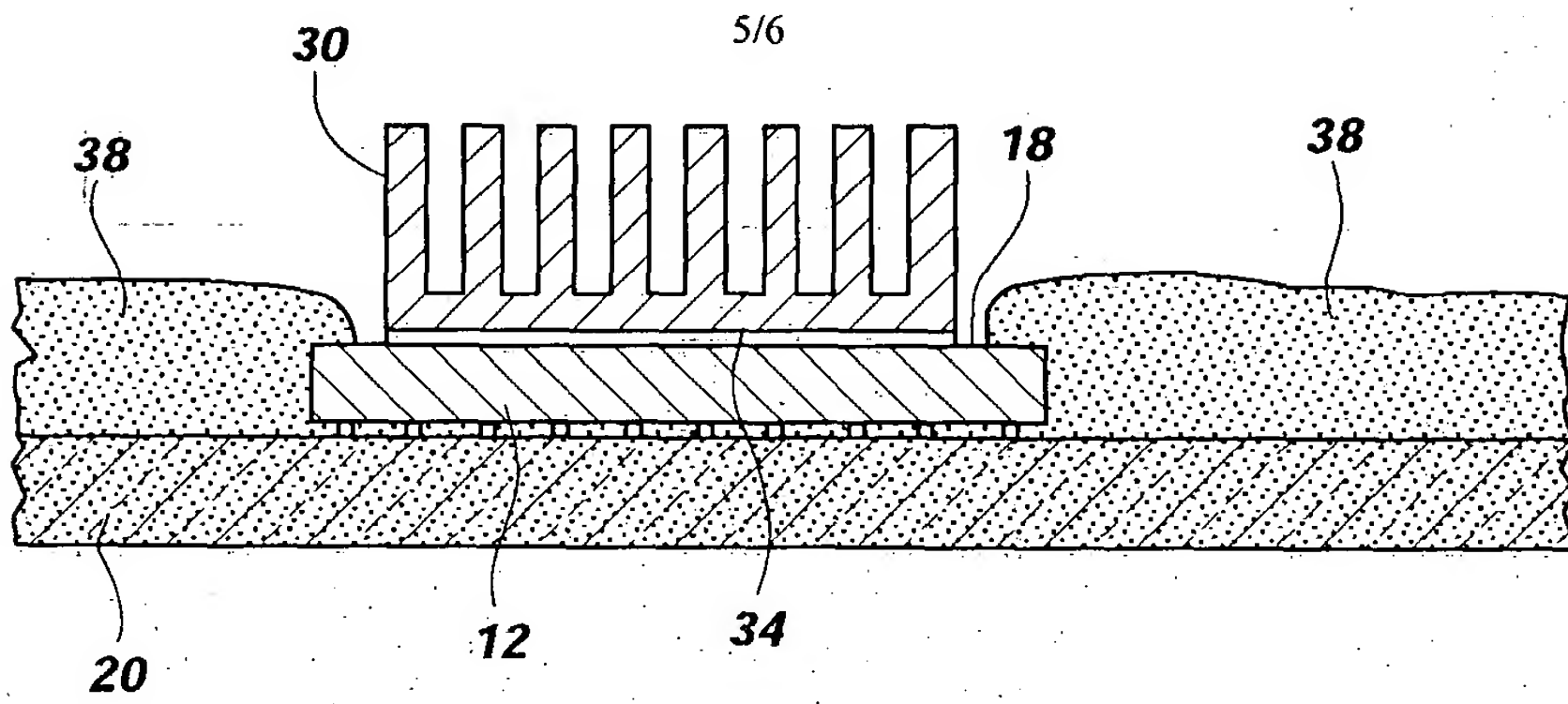
**Fig. 4C**



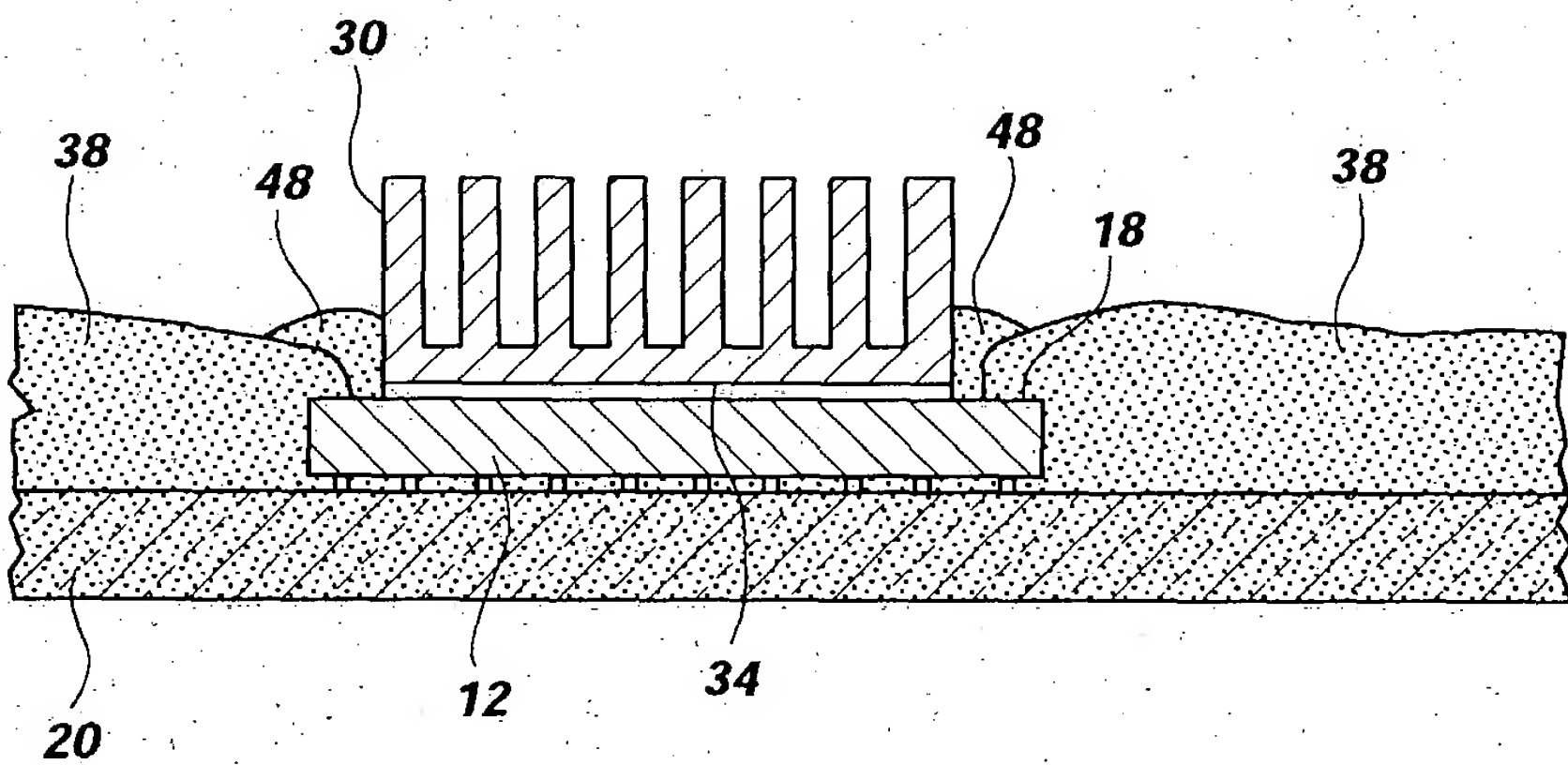
**Fig. 4D**

TITLE: CHIP ON BOARD AND HEAT SINK ATTACHMENT  
METHODS

Inventor: David R. Hembree  
Docket No.: 3592.8US



**Fig. 4E**



**Fig. 4F**



